Specifications for

Blanview TFT-LCD Monitor

Version 1.0 (Please be sure to check the specifications latest version.)

MODEL COM35H3P08ULC

Customer's Approval			
Signature:			
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Version History

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1. Application

This Specification is applicable to 8.88cm (3.5 inch) Blanview TFT-LCD monitor for non-military use.

- ORTUS TECHNOLOGY makes no warranty or assume no liability that use of this Product and/or any information including drawings in this Specification by Purchaser is not infringing any patent or other intellectual property rights owned by third parties, and ORTUS TECHNOLOGY shall not grant to Purchaser any right to use any patent or other intellectual property rights owned by third parties owned by third parties. Since this Specification contains ORTUS TECHNOLOGY's confidential information and copy right, Purchaser shall use them with high degree of care to prevent any unauthorized use, disclosure, duplication, publication or dissemination of ORTUS TECHNOLOGY'S confidential information and copy right.
- If Purchaser intends to use this Products for an application which requires higher level of reliability and/or safety in functionality and/or accuracy such as transport equipment (aircraft, train, automobile, etc.), disaster-prevention/security equipment or various safety equipment, Purchaser shall consult ORTUS TECHNOLOGY on such use in advance.
- © This Product shall not be used for application which requires extremely higher level of reliability and/or safety such as aerospace equipment, telecommunication equipment for trunk lines, control equipment for nuclear facilities or life-support medical equipment.
- ◎ It must be noted as an mechaniacl design manner, especial attention in housing design to prevent arcuation/flexureor caused by stress to the LCD module shall be considered.
- ORTUS TECHNOLOGY assumes no liability for any damage resulting from misuse, abuse, and/or miss-operation of the Product deviating from the operating conditions and precautions described in the Specification.
- ORTUS TECHNOLOGY is not responsible for any nonconformities and defects that are not specified in this specifications.
- ◎ If any issue arises as to information provided in this Specification or any other information, ORTUS TECHNOLOGY and Purchaser shall discuss them in good faith and seek solution.
- © ORTUS TECHNOLOGY assumes no liability for defects such as electrostatic discharge failure occurred during peeling off the protective film or Purchaser's assembly process.

◎ This Product is compatible for RoHS directive.

Object substance	Maximum content [ppm]
Cadmium and its compound	100
Hexavalent Chromium Compound	1000
Lead & Lead compound	1000
Mercury & Mercury compound	1000
Polybrominated biphenyl series (PBB series)	1000
Polybrominated biphenyl ether series (PBDE series)	1000

2. Outline Specifications

2.1 Features of the Product

- 3.5 inch diagonal display, 1440 [H] x 640 [V] dots.
- 6-bit / 262,144 colors.
- Timing generator [TG], Counter-electrode driving circuitry, Built-in power supply circuit.
- Power save (Standby) mode capable.
- Long life & High bright white LED back-light.
- Blanview TFT-LCD, improved outdoor readability.



2.2 Display Method

Items	Specifications	Remarks
Display type	262,144 colors.	
	Blanview, Normally black.	
Driving method	a-Si TFT Active matrix.	
	Line-scanning, Non-interlace.	
Dot arrangement	RGB stripe arrangement.	Refer to "Dot arrangement"
Signal input method	6-bit RGB,parallel input.	
Backlight type	Long life & High bright white LED.	





- Contrast characteristics under 100,000lx. (same condition as direct sunlight.)

With better contrast (higher contrast ratio), Blanview TFT-LCD has the best outdoor readability in three different types of TFT-LCD.

Below chart shows contrast value against panel surface brightness. (Horizontal: Panel surface brightness/ Vertical: Contrast value) LCD panel has enough outdoor readability above our Standard line.



3. Dimensions and Shape

3.1 Dimensions

Items	Specifications	Unit	Remarks
Outline dimensions	63.50[H] × 85.00[V] ×3.03[D]	mm	Exclude FPC cable and
			parts on FPC.
Active area	53.28[H] × 71.04[V]	mm	8.88cm diagonal
Number of dots	1440[H] × 640[V]	dot	
Dot pitch	37.00[H] × 111.00[V]	μm	
Surface hardness of the polarizer	3	Н	Load:2.0N
Weight	30.8	g	Include FPC cable



3.3 Serial № print (S-print)

1) Display Items

S-print indicates the least significant digit of manufacture year (1digit), manufacture month with below alphabet (1letter), model code (5characters), serial number (6digits).

* Contents of Display

<u>* * *****</u> ****** a b c d

	Contents of display								
а	The least significant digit of manufacture year								
b	Manufacture month	anufacture month Jan-A May-E Sep-I							
		Feb-B Jun-F Oct-J							
		Mar-C Jul-G Nov-K							
		Apr-D Aug-H Dec-L							
С	Model code35NFC (Made in Japan)35NGC (Made in Malaysia)								
d	Serial number								

* Example of indication of Serial No. print (S-print)

•Made in Japan

5A35NFC000125

means "manufactured in January 2015, 3.5" NF type, C specifications, serial number 000125"

Made in Malaysia

5A35NGC000125

means "manufactured in January 2015, 3.5" NG type, C specifications, serial number 000125"

2) Location of Serial No. print (S-print) Refer to 3.2 "Outward Form".

3)Others

Please note that it is likely to disappear with an organic solvent about the Serial print.

4. Pin Assignment

No.	Symbol	Function						
1	VSS	Ground						
2	VSS	Ground						
3	VDD	Power supply input.						
4	VCCIO	Logic Interface Power supply input.						
5	VSS	Ground						
6	RESETB	System reset signal input.(Lo: active)						
7	HSYNC	Horizontal sync signal input. (Negative polarity)						
8	VSYNC	Vertical sync signal input.(Negative polarity)						
9	CLK	Clock input for display. (Data Input on the falling edge)						
10	VSS	Ground						
11	D00	Display data input for (B).						
12	D01	00h for black display						
13	D02	D00:LSB D05:MSB						
14	D03							
15	D04	Driver IC carries out gamma conversion internally.						
16	D05							
17	D10	Display data input for (G).						
18	D11	00h for black display						
19	D12	D10:LSB D15:MSB						
20	D13							
21	D14	Driver IC carries out gamma conversion internally.						
22	D15							
23	D20	Display data input for (R).						
24	D21	00h for black display						
25	D22	D20:LSB D25:MSB						
26	D23							
27	D24	Driver IC carries out gamma conversion internally.						
28	D25							
29	VSS	Ground						
30	DE	Input data effective signal. (It is effective for the period of "H")						
31	STBYB	Standby signal (Lo:Standby operation,Hi:Normal operation)						
32	TEST1	Connect to Ground.						
33	NC	OPEN						
34	NC	OPEN						
35	NC	OPEN						
36	NC	OPEN						
37	TEST2	Connect to Ground.						
38	BLH	LED drive power source. (Anode side)						
39	BLL	LED drive power source. (Cathode side)						

- Recommended connector: HIROSE ELECTRIC FH23 series [FH23-39S-0.3SHW(05)]

- Please make sure to check a consistency between pin assignment in "3.2 Outward Form" and your connector pin assignment when designing your circuit.

Inconsistency in input signal assignment may cause a malfunction.

- Since FPC cable has gold plated terminals, gilt finish contact shoe connector is recommended.



6. Absolute Maximum Rating

	0					VSS=0V
Item	Symbol	Condition	Rating		Unit	Applicable terminal
			MIN MAX			
Supply voltage	VDD	Ta=25° C	-0.3	4.6	V	VDD
Logic interface voltage	VCCIO		-0.3	VDD	V	VCCIO
Input voltage for logic	VI		-0.3	VCCIO+0.3	V	CLK,VSYNC,HSYNC,DE
						D[05:00],D[15:10]
						D[25:20],STBYB,RESETB
Forward current	IL	Ta = 25° C		35	mA	BLH-BLL
		Ta = 70° C		15		
Storage temperature range	Tstg		-30	80	°C	
Storage humidity range	Hstg	Non condensing in an environmental				
		moisture at or les	s than 40 ° C90)%RH.		

7. Recommended Operating Conditions

	0						VSS=0V
Item	Symbol	Condition	Rating		Unit	Applicable terminal	
			MIN	TYP	MAX		
Supply voltage	VDD		2.7	3.0	3.6	V	VDD
Logic interface voltage	VCCIO		1.7	1.8	2.5	V	VCCIO
Input voltage for logic	VI		0		VCCIO	V	CLK,VSYNC,HSYNC,DE D[05:00],D[15:10] D[25:20],STBYB,RESETB
Operational temperature range	Тор	Note1,2	-20	+25	+70	°C	Panel surface temperature
Operating humidity range	Нор	Ta≦30° C	20		80	%	
		Ta>30° C	Non condensing in an environmental moisture at or less than 30°C80%RH.				

Note1: This monitor is operatable in this temperature range. With regard to optical characteristics, refer to Item 10."CHARACTERISTICS".

Note 2: Acceptable Forward Current to LED is up to 15mA, when Ta=+70 °C. Do not exceed Allowable Forward Current shown on the chart below.



8. Characteristics

8.1 DC Characteristics

8.1.1 Display Module

	•		(Unless oth	erwise noted, 7	=3.0V,V0	CCIO=1.8V,VSS=0V)	
Item	Symbol	Condition		Rating		Unit	Applicable terminal
			MIN	TYP	MAX		
Input Signal Voltage	VIH	VCCIO=1.7-2.5V	0.7×VCCIO		VCCIO	V	CLK,VSYNC,HSYNC, DE,D[05:00],
	VIL		0		0.3×VCCIO	V	D[15:10],D[25:20], STBYB,RESETB
Operating	IDD	fCLK=19.8MHz		12.0	24.0	mA	VDD
Current	ICCIO	Color bar display		66.0	132.0	μA	VCCIO
Stand-by	IDDS	Other input with		5.0	15.0	μA	VDD
Current	ICCIOS	constant voltage			1.0	μA	VCCIO

8.1.2 Backlight

Item	Symbol	Condition	Rating		Unit	Applicable terminal	
			MIN	TYP	MAX		
Forward current	IL25	Ta=25 ℃		7.1	35.0	mA	BLH – BLL
	IL70	Ta=70 °C	_	—	15.0	mA	
Forward voltage	VL	Ta=25 ℃	_	16.0	16.8	V	
		IL=7.1mA					
Estimated Life	LL	Ta=25 ℃	—	(50,000)	—	hr	
of LED		IL=7.1mA					
		Note					

Note: - The lifetime of the LED is defined as a period till the brightness of the LED decreases to the half of its initial value.

- This figure is given as a reference purpose only, and not as a guarantee.

- This figure is estimated for an LED operating alone.

As the performance of an LED may differ when assembled as a monitor together with a TFT panel due to different environmental temperature.

- Estimated lifetime could vary on a different temperature and usually higher temperature could reduce the life significantly.

7.2 AC Characteristics

(Unless otherwise noted, Ta=25°C,VDD=3.0V,VCCIO=1.8V,VSS=0V)

Item	Symbol	Condition	Rating		Unit	Applicable terminal	
			MIN	TYP	MAX		
CLK frequency	fCLK		18	19.8	27	MHz	CLK
CLK Low period	tw1L	0.3×VCCIO or less	10			ns	
CLK High period	tw1H	0.7×VCCIO or more	10			ns	
Setup time	tsp		10			ns	CLK,VSYNC,
							HSYNC,DE,
Hold time	thd		10			ns	D[05:00],D[15:10]
							D[25:20]



8.3 Input Timing Characteristics

Item	Symbol		Rating		Unit	Applicable terminal	
		MIN	TYP	MAX			
CLK Frequency	fCLK	18	19.8	27	MHz	CLK	
VSYNC Frequency Note	fVSYNC	54	60	66	Hz	VSYNC	
VSYNC Cycle	tv	646	650	700	Н	VSYNC,HSYNC	
VSYNC Pulse Width	tw4H	2	3	50	Н	1	
Vertical Back Porch	tvb	2	3	50	Н	VSYNC,HSYNC,DE,	
Vertical Front Porch	tvf	2	4	50	Н	D[05:00],D[15:10],D[25:20]	
Vertical Display Period	tvdp		640		Н	1	
HSYNC frequency	fHSYNC		39.0	50.0	kHz	HSYNC	
HSYNC Cycle	th	504	508	630	CLK	CLK,HSYNC	
HSYNC Pulse Width	tw5H	5	10	140	CLK	1	
Horizontal Back Porch	thb	5	10	140	CLK	CLK,HSYNC,DE,	
Horizontal Front Porch	thf	5	8	140	CLK	D[05:00],D[15:10],D[25:20]	
Horizontal data start Point	tw5H+thb	19		145	CLK	1	
Horizontal Blanking Period	tw5H+thb+thf	24		150	CLK		
DE Pulse Width	tw6H		480		CLK	CLK,DE	
Horizontal Display Period	thdp		480		CLK	CLK,DE,	
						D[05:00],D[15:10],D[25:20]	

Note: This is recommended spec to get high quality picture on display. It is customer's risk to use out of this frequency.





(19/32)

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9 Power ON/OFF sequence	
VDD Min 0ms *1	
VCCIO Min 1ms *3	
RESETB	
STBYB Min 0ms *4	
VSYNC *2	
CLK *2	MMWMM
	//////////////////////////////////////
	//////////////////////////////////////
DISP ON Display ON Display OF CLK=27MHz:11 frame CLK=19.8MHz:15 frame CLK=27MHz:16 frame CLK=27MHz:16 frame	
CLK=19.8	MHz:12 frame Hz:13 frame

*1 Please start up VDD and VCCIO at the same time or in order of VDD --> VCCIO.

- *2 CLK is used for Gate array CLK on FPC. VSYNC is used for Gate array's inside counter. It becomes the operation after CLK ,VSYNC input.
- *3 After the power supply,Please execute RESETB.
- *4 There is no regulations at time until each signal is supplied from RESETB"H" But meanwhile, It is necessary to fix each signal to "H"or"L".
- *5 It is necessary to supply VSYNC and CLK for 15 frames or more from STBYB "L" to turning off the power supply without leaving the afterimage.

10. Characteristics

10.1 Optical Characteri < Measurement Condition					
Measuring instruments: CS1000 (KONICA MINOLTA), LCD7200(OTSUKA ELECTRONICS					
	EZcontrast160D (ELDIM)				
Driving condition:	Refer to typical rating of the section "Recommended Operating Conditions"				
	Optimized VCOMDC				
Backlight:	IL=7.1mA				
Measured temperature:	Ta=25° C				

MIN Note No. Item Condition TYP MAX Unit Remark Symbol TON [Data]= 40 Ж 1 ms _ _ Response time Rise time 00h→FFh TOFF [Data]= ____ ____ 60 ms Fall time FFh→00h 600 CR [Data]= 360 _ 2 Contrast ratio **Backlight ON** FFh/00h 5.5 _ _ Backlight OFF θL 80 3 Left [Data]= deg Х ____ _ Viewing angle Right θR FFh/00h 80 _ _ deg Up 80 deg φU $CR \ge 10$ _ _ deg Down φD 80 ____ White chromaticity range х [Data]=FFh 4 White Chromaticity y No noticeable burn-in image shall 5 Burn-in be observed after 2 hours of window pattern display. Center brightness [Data]=FFh 160 250 cd/m² 6 Brightness distribution [Data]=FFh 70 % 7 _

* Note number 1 to 7: Refer to the APPENDIX of "Reference Method for Measuring Optical Characteristics".

X Measured in the form of LCD module.



[White Chromaticity Range]

х	у
0.25	0.33
0.25	0.26
0.34	0.26
0.35	0.27
0.35	0.36
0.26	0.36

White Chromaticity Range

10.2 Temperature Characteristics

< Measurement Condition >	
Measuring instruments:	CS1000 (KONICA MINOLTA), LCD7200(OTSUKA ELECTRONICS)
Driving condition:	Refer to typical rating of the section "Recommended Operating Conditions"
	Optimized VCOMDC
Backlight:	IL=7.1mA

	tem		Specif	ication	Remark
'	lem		Ta=-20° C	Ta=70° C	Relliaik
Contrast ratio		CR	40 or more	40 or more	Backlight ON
Response time	Rise time	TON	200 msec or less	30 msec or less	*
Response time	Fall time	TOFF	300 msec or less	50 msec or less	*
Display Quality			No noticeable display defect or ununiformity should be observed.		Use the criteria for judgment specified in the section 11.

* Measured in the form of LCD module.

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11. Criteria of Judgment

11.1 Defective Display and Screen Quality

Test Condition:	Observed TFT-LCD monitor from front during operation with the following conditions
Driving Signal	Raster Pattern (RGB in monochrome, white, black)
Signal condition	[Data] : FFh, BCh, 00h (3steps)
Observation distance	30 cm
Illuminance	200 to 350 lx
Backlight	IL=7.1mA

De	efect item		Defect content	Criteria
	Line defect	Black, white or colo	r line, 3 or more neighboring defective dots	Not exists
>		Uneven brightness	on dot-by-dot base due to defective	Refer to table 1
Quality		TFT or CF, or dust i	s counted as dot defect	
ð		(brighter dot, darker	dot)	
Display	Dot defect	High bright dot: Visi	ble through 2% ND filter at [Data]=00h	
lisp		Low bright dot: Visi	ble through 5% ND filter at [Data]=00h	
		Dark dot: Appear da	ark through white display at [Data]=BCh	
		Invisible through 5%	ND filter at [Data]=00h	ignored
	Dirt	Uneven brightness	(white stain, black stain etc)	Invisible through 1% ND filter
2		Point-like	0.25mm<φ	N=0
Quality	Foreign		0.20<φ≦0.25mm	N≦2
	particle		φ≦0.20mm	Ignored
Screen	particle	Liner	3.0mm <length 0.08mm<width<="" and="" td=""><td>N=0</td></length>	N=0
SCre			length \leq 3.0mm or width \leq 0.08mm	Ignored
0)	Others			Use boundary sample
	Calcia			for judgment when necessary

φ(mm): Average diameter = (major axis + minor axis)/2 Permissible number: N

Table 1					
Area	High bright dot	Low bright dot	Dark dot	Total	Criteria
А	0	2	2	3	Permissible distance between same color bright dots (includes neighboring dots): 3 mm or more
В	2	4	4	6 Permissible distance between same color high bright dots (includes neighboring dots): 5 mm or more	
Total	2	4	4	7	

<Portrait model>

. .



Division of A and B areas B area: Active area Dimensional ratio between A and B areas: 1: 4: 1 (Refer to the left figure)

11.2 Screen and Other Appearance

Testing conditions

Observation distance Illuminance

30cm 1200∼2000 lx

	Item	Criteria	Remark
		lan an in isible defendent a bescher	Angliaghte angle
	Flaw	Ignore invisible defect when the backlight is on.	Applicable area:
zer	Stain		Active area only
Polarizer	Bubble		(Refer to the section
Pol	Dust		3.2 "Outward form")
	Dent		
	S-case	No functional defect occurs	
	FPC cable	No functional defect occurs	

12. Reliability Test

	Test item	Test condition	number of failures /number of examinations
	High temperature storage	Ta=80° C 240hr	0⁄3
	Low temperature storage	Ta=-30° C 240hr	0⁄3
st	High temperature & high	Ta=60° C, RH=90% 240hr	0⁄3
y te	humidity storage	non condensing 🛛 🕺	
Durability test	High temperature operation	Tp=70° C 240hr	0/3
ural	Low temperature operation	Tp=-20° C 240hr	0⁄3
Ď	High temp & humid operation	Tp=40°C, RH=90% 240hr	0⁄3
		non condensing **	
	Thermal shock storage	-30←→80° C(30min/30min) 100 cycles	0⁄3
		Confirms to EIAJ ED-4701/300	0⁄3
est	Electrostatic discharge test (Non operation)	C=200pF,R=0Ω,V=±200V	
		Each 3 times of discharge on and power supply	
al te		and other terminals.	
Mechanical environmental test	Surface discharge test (Non operation)	C=250pF, R=100Ω, V=±12kV	0⁄3
		Each 5 times of discharge in both polarities	
/iro	(Non operation)	on the center of screen with the case grounded.	
env	Vibration test	Total amplitude 1.5mm, f=10 \sim 55Hz, X,Y,Z	0⁄3
cal	Vibration test	directions for each 2 hours	
anic		Use ORTUS TECHNOLOGY original jig	0⁄3
sch		(see next page)and make an impact with	
Mec	Impact test	peak acceleration of 1000m/s2 for 6 msec with	
		half sine-curve at 3 times to each X, Y, Z directions	
		in conformance with JIS 60068-2-27-2011.	
st		Acceleration of 19.6m/s ² with frequency of	0∕1 Packing
te	Packing vibration-proof test	10→55→10Hz, X,Y, Zdirection for each	
Packing test		30 minutes	
ack	Packing drop test	Drop from 75cm high.	0∕1 Packing
д.		1 time to each 6 surfaces, 3 edges, 1 corner	

Note:Ta=ambient temperature Tp=Panel temperature

% The profile of high temperature/humidity storage and High Temperature/humidity operation (Pure water of over 10M Ω ·cm shall be used.)



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Table2.Reliability Criteria

Measure the parameters after leaving the monitor at the ordinary temperature for 2 hours or more after the test completion.

item	Standard	Remarks
Display quality	No visible abnormality shall be seen.	As criteria of
		"11 Criteria of Judgment".
Contrast ratio	40 or more	Backlight ON

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Remark: The return of packing materials is not required.

	Packing item name	Specs., Material
1	TRAY	A-PET
2	FOAM SHEET	Anti-static polyethilene
3	INNER CARTON	Corrugated cardboard
4	INNER BOARD	Corrugated cardboard
5	OUTER CARTON	Corrugated cardboard
6	Drier	Moisture absorber
\bigcirc	EXTRA OUTER CARTON	Corrugated cardboard
8	SEALING BAG	
9	Packing tape	

Step 1. Each product is to be placed in one of the cut-outs of the tray with the display surface facing upward.
FOAM SHEET is put on the products.
(10 products × 1 decker=10 products per tray)

Step 2. Each tray is to be piled up in same orientation and the trays be in a stack of 10.

One empty tray is to be put on the top of stack of 10 trays.

Step 3. 2 packs of moisture absorbers are to be placed on the top tray as shown in the drawing.

Put piled trays into a sealing bag. Vacuum and seal the sealing bag with the vacuum sealing

machine.

- Step 4. The stack of trays in the plastic back is to be inserted into a inner carton.
- Step 5. A corrugated board is to be placed on the top and on the bottom of the inner carton. The two corrugated boards and the inner carton is to be inserted into an outer carton.
- Step 6. The outer carton needs to sealed with packing tape as shown in the drawing.

The model number, quantity of products, and shipping date are to be printed on the outer carton.

If necessary, shipping labels or impression markings are to be put on the outer carton.

Step 7. The outer carton is to be inserted into a extra outer carton with same direction.

The extra outer carton needs to sealed with packing tape as shown in the drawing.

Step 8. The model number, quantity of products, and shipping date are to be printed on the extra outer carton.

If necessary, shipping labels or impression markings are to be put on the extra outer carton.



Dimension of e	extra outer carton	
D : Approx.	(338mm)	
W : Approx.	(549mm)	
H : Approx.	(198mm)	
Quantity of products pac	ked in one carton:	100
Gross weight : App	orox. 7.3kg	

14. Handling Instruction

14.1 Cautions for Handling LCD panels

	<u>_!</u> Caution
(1)	Do not make an impact on the LCD panel glass because it may break and you may get injured from it.
(2)	If the glass breaks, do not touch it with bare hands. (Fragment of broken glass may stick you or you cut yourself on it.
(3)	If you get injured, receive adequate first aid and consult a medial doctor.
(4)	Do not let liquid crystal get into your mouth. (If the LCD panel glass breaks, try not let liquid crystal get into your mouth even toxic property of liquid crystal has not been confirmed.
(5)	If liquid crystal adheres, rinse it out thoroughly. (If liquid crystal adheres to your cloth or skin, wipe it off with rubbing alcohol or wash it thoroughly with soap. If liquid crystal gets into eyes, rinse it with clean water for at least 15 minutes and consult an eye doctor.
(6)	If you scrap this products, follow a disposal standard of industrial waste that is legally valid in the community, country or territory where you reside.
(7)	Do not connect or disconnect this product while its application products is powered on.
(8)	Do not attempt to disassemble or modify this product as it is precision component.
(9)	If a part of soldering part has been exposed, and avoid contact (short-circuit) with a metallic part of the case etc. about FPC of this model, please. Please insulate it with the insulating tape etc. if necessary. The defective operation is caused, and there is a possibility to generation of heat and the ignition.
(10)	Since excess current protection circuit is not built in this TFT module, there is the possibility that LCD module or peripheral circuit become feverish and burned in case abnormal operation is generated. We recommend you to add excess current protection circuit to power supply.
(11)	The devices on the FPC are damageable to electrostatic discharge, because the tarminals of the devices are exposed. Wear grounded wrist-straps and use electrostatic neutralization blowers to prevent static charge and discharge when handling the TFT monitors. Designate an appropriate operating area, and set equipment, tools, and machines properly when handling this product.

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14.2 Precautions for Handling

- Wear finger tips at incoming inspection and for handling the TFT monitors to keep display quality and keep the working area clean.
 Do not touch the surface of the monitor as it is easily scratched.
- Wear grounded wrist-straps and use electrostatic neutralization blowers to prevent static charge and discharge when handling the TFT monitors as the LED in this TFT monitors is damageable to electrostatic discharge. Designate an appropriate operating area, and set equipment, tools, and machines properly when handling this product.
- Avoid strong mechanical shock including knocking, hitting or dropping to the TFT monitors for protecting their glass parts. Do not use the TFT monitors that have been experienced dropping or strong mechanical shock.
- 4) Do not use or storage the TFT monitors at high temperature and high humidity environment. Particularly, never use or storage the TFT monitors at a location where condensation builds up.
- 5) Avoid using and storing TFT monitors at a location where they are exposed to direct sunlight or ultraviolet rays to prevent the LCD panels from deterioration by ultraviolet rays.
- 6) Do not stain or damage the contacts of the FPC cable .
 FPC cable needs to be inserted until it can reach to the end of connector slot.
 During insertion, make sure to keep the cable in a horizontal position to avoid an oblique insertion.
 Otherwise, it may cause poor contact or deteriorate reliability of the FPC cable.
- 7) The FPC cable is a design very weak to the bend and the pull as it is fixed with the tape. Do not bend or pull the FPC cable or carry the TFT monitor by holding the FPC cable.
- Peel off the protective film on the TFT monitors during mounting process. Refer to the section 14.5 on how to peel off the protective film. We are not responsible for electrostatic discharge failures or other defects occur when peeling off the protective film.

14.3 Precautions for Operation

- Since this TFT monitors are not equipped with light shielding for the driver IC, do not expose the driver IC to strong lights during operation as it may cause functional failures.
- In case of powering up or powering off this LCD module, be sure to comply the sequence as instructed in this specification.
- Do not plug in or out the FPC cable while power supply is switch on. Plug the FPC cable in and out while power supply is switched off.
- 4) Do not operate the TFT monitors in the strong magnetic field. It may break the TFT monitors.
- 5) Do not display a fixed image on the screen for a long time.
 Use a screen-saver or other measures to avoid a fixed image displayed on the screen for a long time.
 Otherwise, it may cause burn-in image on the screen due the characteristics of liquid crystal.

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14.4 Storage Condition for Shipping Cartons

Storage environment

Temperature	0 to 40° C
Humidity	60%RH or less
	No-condensing occurs under low temperature with high humidity condition.
Atmosphere	No poisonous gas that can erode electronic components and/or wiring materials should be detected.
 Time period 	3 months
Unpacking	To prevent damages caused by static electricity, anti-static precautionary measures (e.g. earthing, anti-static mat) should be implemented.

Maximum piling up 7 cartons

14.5 Precautions for Peeling off the Protective film

The followings work environment and work method are recommended to prevent the TFT monitors from static damage or adhesion of dust when peeling off the protective films.

A) Work Environment

- a) Humidity: 50 to 70 %RH, Temperature15 to 27 $^\circ\text{C}$
- b) Operators should wear conductive shoes, conductive clothes, conductive finger tips and grounded wrist-straps. Anti-static treatment should be implemented to work area's floor.
- c) Use a room shielded against outside dust with sticky floor mat laid at the entrance to eliminate dirt.

B) Work Method

- The following procedures should taken to prevent the driver ICs from charging and discharging.
- a) Use an electrostatic neutralization blower to blow air on the TFT monitors to its lower left when the FPC cable facing to the leftside.
 Optimize direction of the blowing air and the distance between the TFT monitors and the electrostatic neutralization blower.
- b) Put an adhesive tape (Scotch tape, etc) at the lower left corner area of the protective film to prevent scratch on surface of TFT monitors.
- c) Peel off the adhesive tape slowly (spending more than 2 secs to complete) by pulling it to opposite direction.

Direction of blowing air (Optimize air direction and the distance)

APPENDIX

Reference Method for Measuring Optical Characteristics and Performance

1. Measurement Conditio	on (Backlight ON)
Measuring instruments:	CS1000 (KONICA MINOLTA), LCD7200(OTSUKA ELECTRONICS), EZcontrast160D (ELDIM)
Driving condition:	Refer to typical rating of the section "Recommended Operating Conditions"
Measured temperature:	25°C unless specified
Measurement system:	See the chart below. The luminance meter is placed on the normal line of measurement system.
Measurement point:	At the center of the screen unless otherwise specified



Measurement is made after 30 minutes of lighting of the backlight.

Measurement point:

At the center point of the screen Brightness distribution: 9 points shown in the following drawing.

<Portrait model>



Dimensional ratio of active area

Backlight IL=7.1mA



ne	Measure output signal waveform by the luminance meter when raster of window pattern is changed from white to black and from black to white. Black White Black White brightness 100% 90% 10% 0%	ICD7200	Black display [Data]=00h White display [Data]=FFh TON Rise time TOFF Fall time
	White brightness		TON Rise time TOFF
			-
	90%		-
	\leftrightarrow		
	Black		
	minimum luminance Y2([Data]=00h) at the center of the screen by displaying raster or window pattern. Then calculate the ratio between these two values. Contrast ratio = Y1/Y2 Diameter of measuring point: 8mmφ(CS1000)	CS1000 LCD7200	Backlight ON Backlight OF
ngle	Move the luminance meter from right to left and up and down and determine the angles where	EZcontrast160D	
/hite		CS1000	
	Visually check burn-in image on the screen after 2 hours of "window display" ([Data]=FFh/00h).		At optimized VCOMDC
enter rightness	Measure the brightness at the center of the screen.	CS1000	
rightness stribution	-	CS1000	
	wing gle rizontalθ rticalφ ite omaticity m-in nter ghtness ghtness	Contrast ratio = Y1/Y2 Diameter of measuring point: 8mmφ(CS1000) Diameter of measuring point: 8mmφ(LCD7200)wing gleMove the luminance meter from right to left and up and down and determine the angles where contrast ratio is 10.rizontalθ tricalφMeasure chromaticity coordinates x and y of CIE1931 colorimetric system at [Data] =FFh Color matching faction: 2°viewrn-inVisually check burn-in image on the screen after 2 hours of "window display" ([Data]=FFh/00h).nter ghtnessMeasure the brightness at the center of the screen. ghtnessghtness(Brightness distribution) = 100 x B/A %	minimum luminance Y2([Data]=00h) at the center of the screen by displaying raster or window pattern. Then calculate the ratio between these two values. Contrast ratio = Y1/Y2 Diameter of measuring point: 8mmφ(CS1000) Diameter of measuring point: 8mmφ(LCD7200)LCD7200wing gleMove the luminance meter from right to left and up and down and determine the angles where contrast ratio is 10.EZcontrast160Dtitle omaticityMeasure chromaticity coordinates x and y of CIE1931 colorimetric system at [Data] =FFh Color matching faction: 2°viewCS1000mr-in after 2 hours of "window display" ([Data]=FFh/00h).CS1000mter ghtness (Brightness distribution) = 100 x B/A % A : max. brightness of the 9 pointsCS1000